

# NPN Silicon Epitaxial Transistor

## BCP56 Series

These NPN Silicon Epitaxial transistors are designed for use in audio amplifier applications. The device is housed in the SOT-223 package, which is designed for medium power surface mount applications.

### Features

- High Current: 1.0 A
- The SOT-223 package can be soldered using wave or reflow. The formed leads absorb thermal stress during soldering, eliminating the possibility of damage to the die
- Available in 12 mm Tape and Reel
  - Use BCP56T1G to Order the 7 inch/1000 Unit Reel
  - Use BCP56T3G to Order the 13 inch/4000 Unit Reel
- PNP Complement is BCP53T1G
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	80	Vdc
Collector-Base Voltage	$V_{CBO}$	100	Vdc
Emitter-Base Voltage	$V_{EBO}$	5	Vdc
Collector Current	$I_C$	1	Adc
Collector Current - Peak (Note 1)	$I_{CM}$	2	Adc
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ (Note 2) Derate above $25^\circ\text{C}$	$P_D$	1.5 12	W mW/°C
Operating and Storage Temperature Range	$T_J, T_{stg}$	-65 to 150	°C

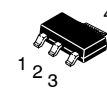
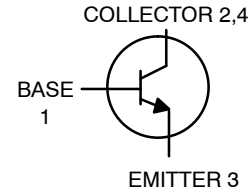
### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient (surface mounted)	$R_{\theta JA}$	83.3	°C/W
Maximum Temperature for Soldering Purposes Time in Solder Bath	$T_L$	260 10	°C Sec

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

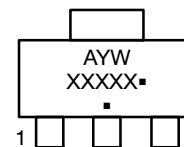
1. Reference SOA curve.
2. Device mounted on a FR-4 glass epoxy printed circuit board 1.575 in x 1.575 in x 0.0625 in; mounting pad for the collector lead = 0.93 sq in.

## MEDIUM POWER NPN SILICON HIGH CURRENT TRANSISTOR SURFACE MOUNT



**SOT-223  
CASE 318E  
STYLE 1**

### MARKING DIAGRAM



XXXXX = Specific Device Code  
 A = Assembly Location  
 Y = Year  
 W = Work Week  
 ■ = Pb-Free Package  
 (Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

## BCP56 Series

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristics	Symbol	Min	Typ	Max	Unit
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#### OFF CHARACTERISTICS

Collector-Base Breakdown Voltage ( $I_C = 100\ \mu\text{Adc}$ , $I_E = 0$ )	$V_{(BR)CBO}$	100	-	-	Vdc
Collector-Emitter Breakdown Voltage ( $I_C = 1.0\ \text{mAdc}$ , $I_B = 0$ )	$V_{(BR)CEO}$	80	-	-	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 10\ \mu\text{Adc}$ , $I_C = 0$ )	$V_{(BR)EBO}$	5.0	-	-	Vdc
Collector-Base Cutoff Current ( $V_{CB} = 30\ \text{Vdc}$ , $I_E = 0$ )	$I_{CBO}$	-	-	100	nAdc
Emitter-Base Cutoff Current ( $V_{EB} = 5.0\ \text{Vdc}$ , $I_C = 0$ )	$I_{EBO}$	-	-	10	$\mu\text{Adc}$

#### ON CHARACTERISTICS (Note 3)

DC Current Gain ( $I_C = 5.0\ \text{mA}$ , $V_{CE} = 2.0\ \text{V}$ ) ( $I_C = 150\ \text{mA}$ , $V_{CE} = 2.0\ \text{V}$ )  ( $I_C = 500\ \text{mA}$ , $V_{CE} = 2.0\ \text{V}$ )	All Part Types BCP56 BCP56-10 BCP56-16 All Types	$h_{FE}$	25 40 63 100 25	- - - - -	- 250 160 250 -	-
Collector-Emitter Saturation Voltage ( $I_C = 500\ \text{mAdc}$ , $I_B = 50\ \text{mAdc}$ )		$V_{CE(sat)}$	-	-	0.5	Vdc
Base-Emitter On Voltage ( $I_C = 500\ \text{mAdc}$ , $V_{CE} = 2.0\ \text{Vdc}$ )		$V_{BE(on)}$	-	-	1.0	Vdc

#### SWITCHING CHARACTERISTICS

Rise Time ( $V_{CC} = 30\ \text{Vdc}$ , $I_C = 150\ \text{mA}$ , $I_{B1} = 15\ \text{mA}$ )	$t_r$	-	14	-	ns
Delay Time ( $V_{CC} = 30\ \text{Vdc}$ , $I_C = 150\ \text{mA}$ , $I_{B1} = 15\ \text{mA}$ )	$t_d$	-	9	-	ns
Storage Time ( $V_{CC} = 30\ \text{Vdc}$ , $I_C = 150\ \text{mA}$ , $I_{B1} = 15\ \text{mA}$ , $I_{B2} = 15\ \text{mA}$ )	$t_s$	-	714	-	ns
Fall Time ( $V_{CC} = 30\ \text{Vdc}$ , $I_C = 150\ \text{mA}$ , $I_{B1} = 15\ \text{mA}$ , $I_{B2} = 15\ \text{mA}$ )	$t_f$	-	58	-	ns

#### DYNAMIC CHARACTERISTICS

Current-Gain - Bandwidth Product ( $I_C = 10\ \text{mAdc}$ , $V_{CE} = 5.0\ \text{Vdc}$ , $f = 35\ \text{MHz}$ )	$f_T$	-	130	-	MHz
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Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

# BCP56 Series

## TYPICAL ELECTRICAL CHARACTERISTICS

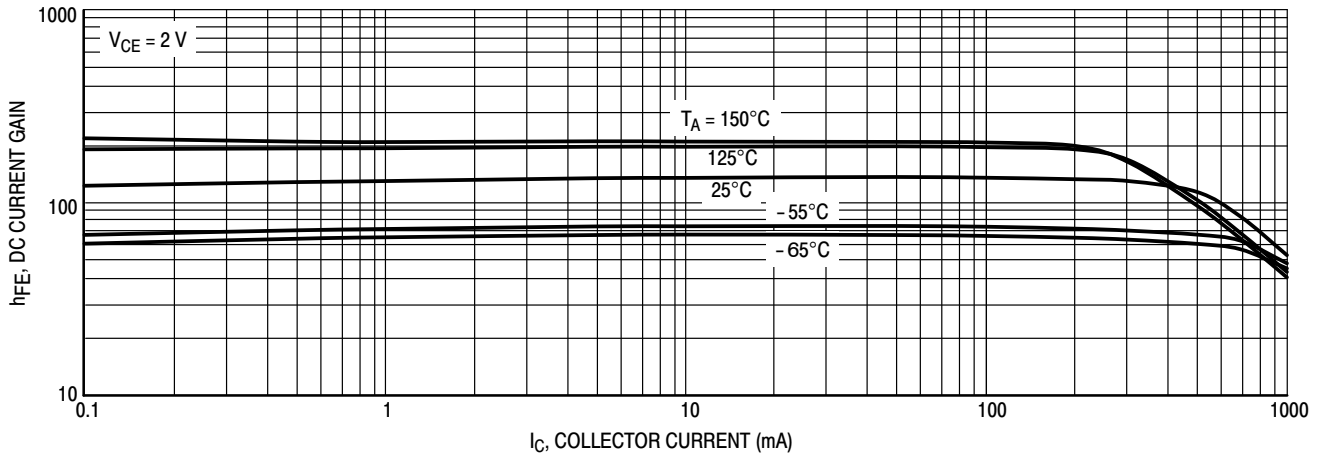


Figure 1. DC Current Gain

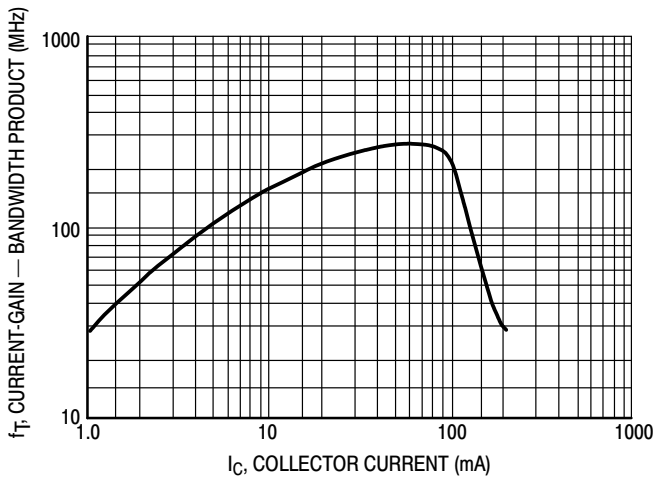


Figure 2. Current-Gain - Bandwidth Product

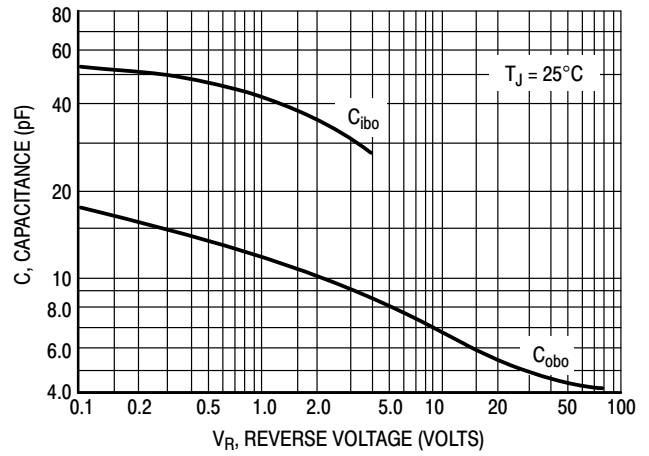


Figure 3. Capacitance

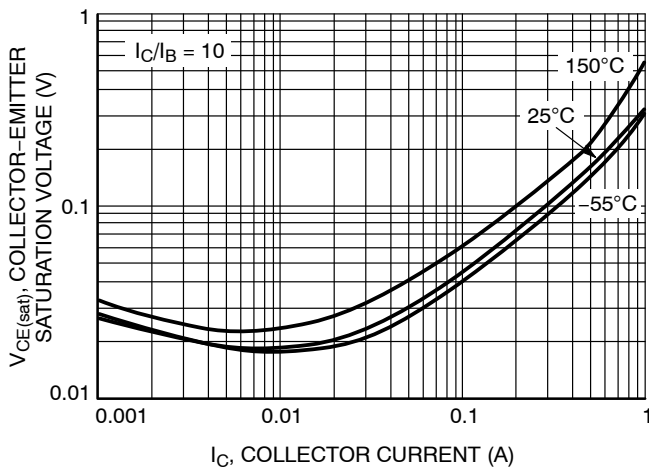


Figure 4. Collector Emitter Saturation Voltage vs. Collector Current

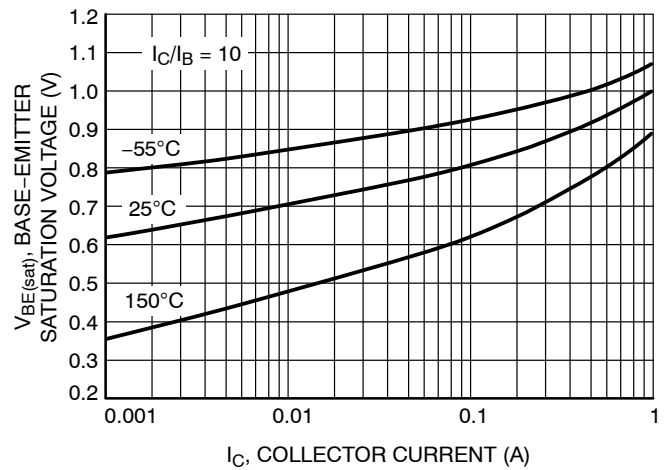
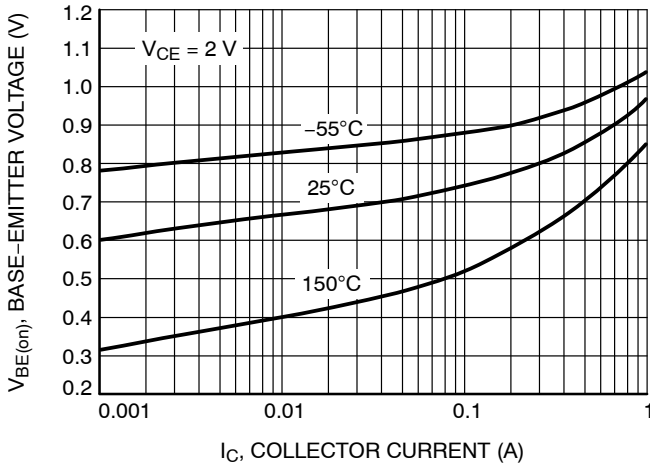


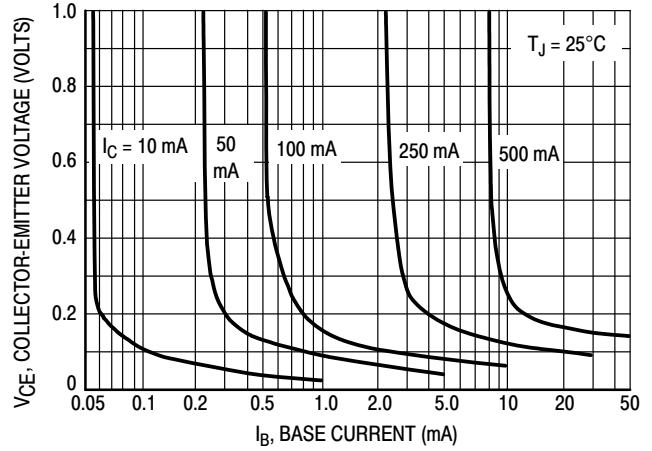
Figure 5. Base Emitter Saturation Voltage vs. Collector Current

# BCP56 Series

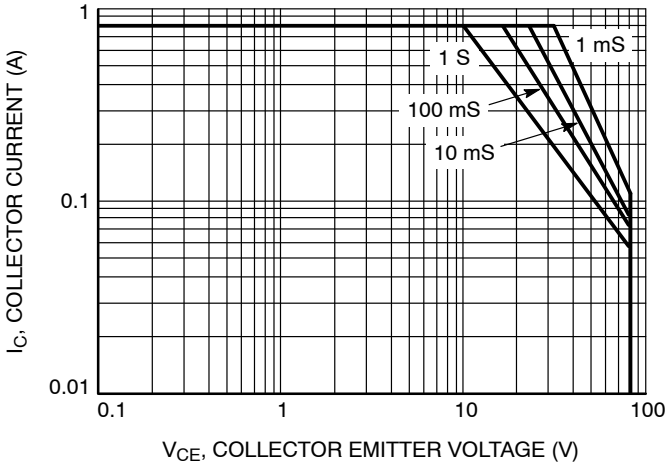
## TYPICAL ELECTRICAL CHARACTERISTICS



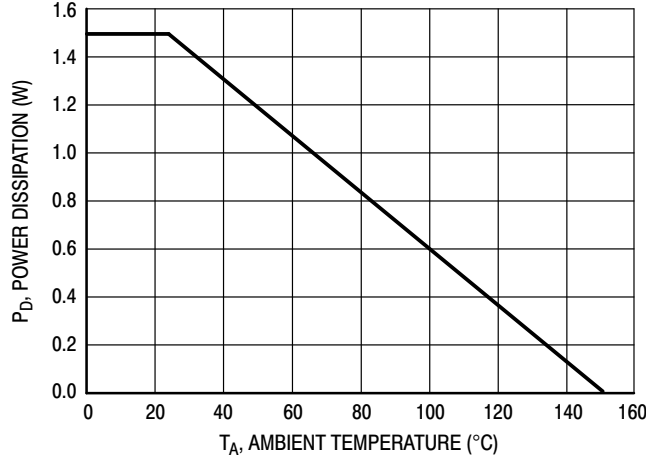
**Figure 6. Base Emitter Voltage vs. Collector Current**



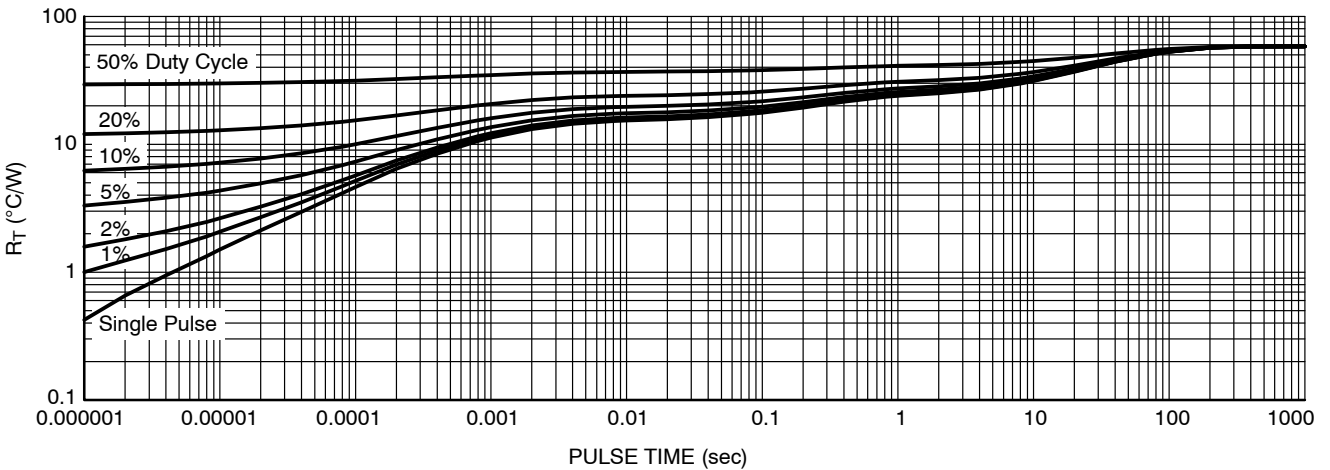
**Figure 7. Collector Saturation Region**



**Figure 8. Safe Operating Area**



**Figure 9. Power Derating Curve**



**Figure 10. Thermal Response**

## BCP56 Series

### ORDERING INFORMATION

Device	Marking	Package	Shipping†
BCP56T1G	BH	SOT-223 (Pb-Free)	1000 / Tape & Reel
SBCP56T1G*			
BCP56T3G	BH	SOT-223 (Pb-Free)	4000 / Tape & Reel
SBCP56T3G*			
BCP56-10T1G	BH-10	SOT-223 (Pb-Free)	1000 / Tape & Reel
SBCP56-10T1G*			
NSVBCP56-10T3G*	BH-10	SOT-223 (Pb-Free)	4000 / Tape & Reel
BCP56-16T1G	BH-16	SOT-223 (Pb-Free)	1000 / Tape & Reel
SBCP56-16T1G*			
BCP56-16T3G	BH-16	SOT-223 (Pb-Free)	4000 / Tape & Reel
SBCP56-16T3G*			

### DISCONTINUED (Note 4)

BCP56-10T3G	BH-10	SOT-223 (Pb-Free)	4000 / Tape & Reel
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†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

4. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on [www.onsemi.com](http://www.onsemi.com).

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